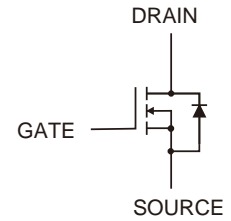
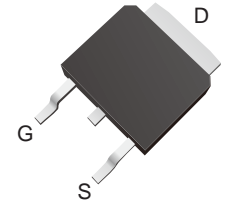


## N-Channel Mosfet

### Features

- Advanced trench process technology
- Reliable and rugged
- High density cell design for ultra low On-Resistance
- Lead free in comply with EU RoHS 2011/65/EU directives



### Ordering Information

Part Number	Marking	Shipping	Reel
LTM14N100-TR2K5	14N100	2500PCS Tape&Reel	13 inches

### Maximum Ratings (Ta = 25°C)

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-Source Voltage	100	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current ( $T_C=25^\circ\text{C}$ )	14	A
	Continuous Drain Current ( $T_C=100^\circ\text{C}$ )	8.5	
$I_{DM}$	Pulsed Drain Current $T_J=25^\circ\text{C}^{*1}$	60	A
$E_{AS}$	Single Pulsed Avalanche Energy <sup>*2</sup>	20	mJ
$P_D$	Power Dissipation <sup>*1</sup>	46	W
$R_{\theta JC}$	Thermal Resistance from Junction to Case <sup>*1</sup>	2.7	$^\circ\text{C}/\text{W}$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 ~ +150	$^\circ\text{C}$

**Electrical Characteristics** ( $T_a = 25\text{ }^\circ\text{C}$ )

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Off characteristics</b>						
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0V, I_D = 250\mu A$	100			V
$I_{DSS}$	Zero gate voltage drain current	$V_{DS} = 100V, V_{GS} = 0V$			1	$\mu A$
$I_{GSS}$	Gate-body leakage current	$V_{DS} = 0V, V_{GS} = \pm 20V$			$\pm 100$	nA
<b>On characteristics</b> *4						
$V_{GS(th)}$	Gate-threshold voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.2	1.8	2.4	V
$R_{DS(on)}$	Static drain-source on-resistance*3	$V_{GS} = 10V, I_D = 4A$ $V_{GS} = 4.5V, I_D = 3A$		113 135	150 190	m $\Omega$
<b>Dynamic characteristics</b>						
$C_{iss}$	Input capacitance	$V_{DS} = 25V,$ $V_{GS} = 0V,$ $f = 1MHz$		1084		pF
$C_{oss}$	Output capacitance			52		
$C_{rss}$	Reverse transfer capacitance			41		
$Q_g$	Total Gate Charge	$V_{DS} = 50V,$ $V_{GS} = 0\text{ to }10V,$ $I_D = 10A$		22		nC
$Q_{gs}$	Gate Source Charge			3		
$Q_{gd}$	Gate Drain("Miller") Charge			6.1		
<b>Switching characteristics</b>						
$t_d(on)$	Turn-on delay time	$V_{DD} = 50V, V_{GS} = 10V,$ $R_G = 3\Omega, I_D = 10A$		14		ns
$t_r$	Turn-on rise time			5.5		
$t_d(off)$	Turn-off delay time			28		
$t_f$	Turn-off fall time			5.2		
<b>Drain-Source Diode Characteristics and Max Ratings</b>						
$I_S$	Maximum Continuous Drain to Source Diode Forward Current				15	A
$I_{SM}$	Maximum Pulsed Drain to Source Diode Forward Current				60	A
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_S = 15A$			1.2	V
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F = 10A,$ $di/dt = 100A/\mu s$		30		ns
$Q_{rr}$	Body Diode Reverse Recovery Charge				42	

**Notes :**

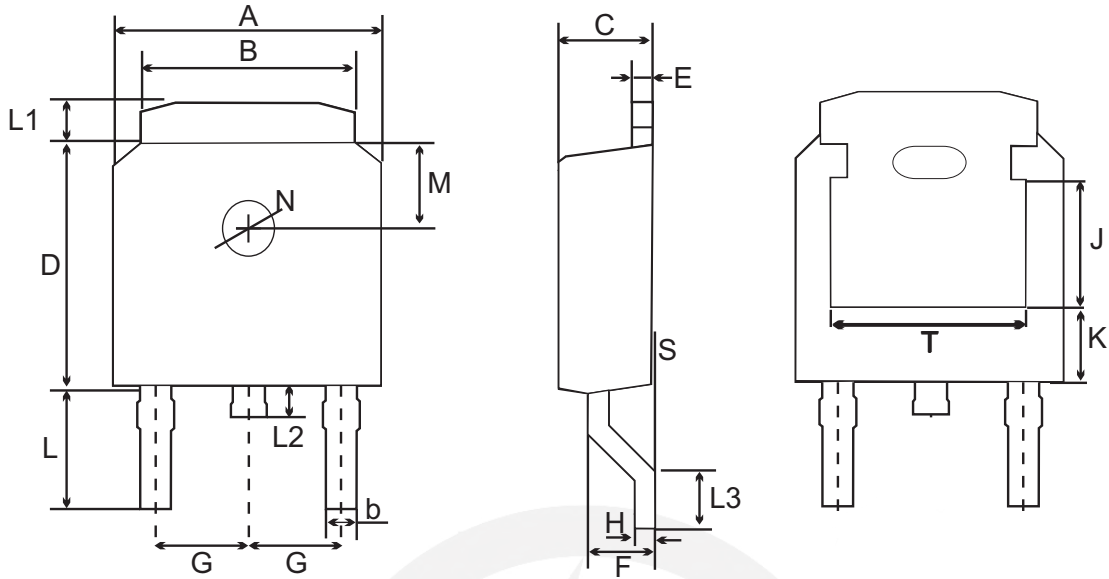
\*1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

\*2. EAS condition:  $V_{DD} = 50V, V_{GS} = 10V, L = 0.5mH, R_g = 25\Omega, L = 0.5mH, I_{AS} = 9A$  Starting  $T_J = 25^\circ\text{C}$ .

\*3. Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 0.5\%$ .



TO-252 Package Outline



UNIT	A	B	b	C	D	E	F	G	H	L	L1	L2	L3	S	M	N	J	K	T	
mm	max	6.7	5.5	0.8	2.5	6.3	0.6	1.8	2.29 TYPICAL	0.55	3.1	1.2	1.0	1.75	0.23	1.8 TYPICAL	1.3 TYPICAL	3.16 ref.	1.80 ref.	4.83 ref.
	typ	6.6	5.3	0.7	2.3	6.1	0.5	1.5		0.50	2.8	1.0	0.8	1.30	0.15					
	min	6.3	5.1	0.3	2.1	5.9	0.4	1.3		0.45	2.7	0.8	0.6	1.00	0.0					





Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T <sub>L</sub> to T <sub>P</sub> )	3°C/second max.
Preheat	
-Temperature Min (T <sub>S min</sub> )	150°C
-Temperature Max (T <sub>S max</sub> )	200°C
-Time (min to max) (t <sub>s</sub> )	60-180 seconds
T <sub>S max</sub> to T <sub>L</sub>	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T <sub>L</sub> )	217°C
-Time (t <sub>L</sub> )	60-150 seconds
Peak Temperature (T <sub>P</sub> )	260°C
Time within 5°C of actual Peak Temperature (t <sub>p</sub> )	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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## Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision content	Revision Reason	Revision Person	Note
01	2024.4.18	2024.4.18	3.0	New File	/	Ding	
02	2025.06.12	2025.06.12	3.1	Update packaging information	/	Ding	